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NEWS

[November 10, 2010]

## Digi introduces ConnectCore 3G

Nov 10, 2010 (Datamonitor via COMTEX) -- Digi International has introduced the ConnectCore 3G, an embedded module with integrated application processing and Qualcomm Gobi technology.

Gobi technology supports High Speed Packet Access (HSPA) or Evolution-Data Optimized (EV-DO) networks, the two standards for 3G data networks, from the same cellular radio. Ideal for developing remote device management solutions in energy, fleet management, digital signage, industrial automation, security/access control and other markets, customers can now develop one solution for use anywhere in the world with the same hardware.

The ConnectCore 3G offers complete support for iDigi, the embedded cloud computing platform for M2M network management. iDigi enables secure remote access, control and management of network-connected devices and complete cloud-based application development.

The ConnectCore3G can be programmed using iDigi Device Integration Application (iDigi Dia) or open-source Python. It also includes a familiar Eclipse-based integrated development environment that allows Web developers to develop embedded applications.

The ConnectCore 3G is a member of the ConnectCore 9P 9215 ARM9-based Ethernet

networking module family. Featuring cellular, Wi-Fi and wired versions, ConnectCore 9P 9215 modules are pin-compatible and interchangeable.

ConnectCore 9P 9215 modules include two Flexible Interface Modules (FIMs) that allow customers to load and use application-specific interfaces such as Secure Digital, Controller Area Network (CAN), 1-Wire, additional UARTs and others. This allows users to custom configure the module for specific application needs. The modules also offer advanced networking protocols like IPv6, SNMPv3 and SSL.

"The ConnectCore 3G is perfect for device manufacturers that are tired of deciding between HSPA and EV-DO or doing two hardware developments to satisfy worldwide connectivity requirements," said Larry Kraft, senior vice president of global sales and marketing, Digi International. "And as a System-on-Module with robust application processing capability, it is an ideal core platform for OEMs to rapidly develop globally connected devices."

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